

Customer No.: 31561  
Application No.: 10/710,637  
Docket No.: 11514-US-PA

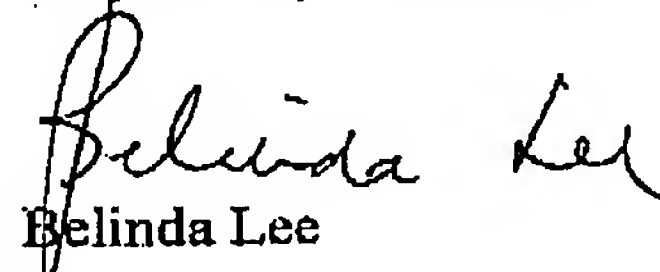
**REMARKS**

In response to the Office Action, mailed on December 23, 2005, a complete listing of all of the claims is presented herewith. Applicant would like to elect Group I, claims 1-12, drawn to a method of forming a semiconductor device, classified in class 438, subclass 401. Please cancel Group II, claims 13-23, drawn to a semiconductor device, classified in class 257, subclass 797, without waiver, prejudice or disclaimer.

If the Examiner believes that a telephone conference would expedite the examination of the above-identified patent application, the Examiner is invited to call the undersigned.

Date : Jan . 20 . 2006

Respectfully submitted,

  
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